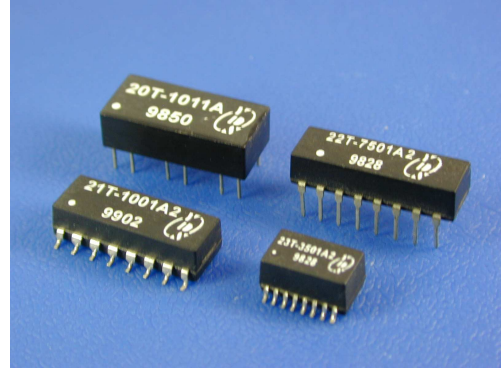


FEATURES

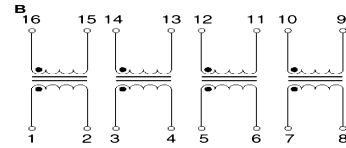
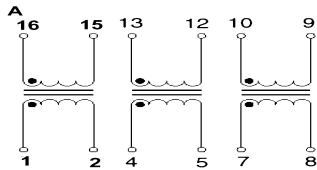
- Low leakage inductance and coupling capacitance for faster rise times
- Small form factor, 50 mil lead spacing
- Through hole, auto-insertable, Surface Mount, 16-pin package



ELECTRICAL SPECIFICATIONS @25°C-Operating temperature 0°C TO 70°C

PART NUMBER	Tums Ratio (±5%)	Primary Pins	Primary Sine Wave OCL(μH) (+/- 20%)	Primary ET-Constant (V-us MIN)	Rise Time	Interwinding Capacitance CWW' (pF MAX)	Leakage Inductance LL' (μH MAX)	PRI.DCR (Ω MAX)	Shem.	Hipot (Vrms)
23T-4001A2	1:1	1-2/4-5/7-8	40(min)	2.1	3.0	8	0.20	0.25	A	2000
20T-7501A2	1:1	1-2/4-5/7-8	75	2.4	3.5	10	0.25	0.30	A	2000
22T-1011A	1:1	1-2/4-5/7-8	100	2.1	3.0	10	0.20	0.30	A	500

SCHEMATICS



MARKINGS AND DIMENSIONS

